



60V P-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

-								
	BV _{DSS}	R _{DS(ON)} Max	Ι _D T _C = +25°C					
	-60V	$110m\Omega @ V_{GS} = -10V$	-14A					
		140mΩ @ V_{GS} = -4.5V	-12A					

Description and Applications

This MOSFET is designed to meet the stringent requirements of Automotive applications. It is qualified to AEC-Q101, supported by a PPAP and is ideal for use in:

- DC-DC Converters
- Power Management Functions
- Analog Switch

Features and Benefits

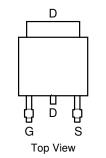
- Low On-Resistance
- Low Input Capacitance
- Totally Lead-Free & Fully RoHS Compliant (Note 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

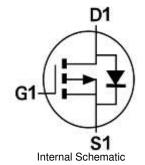
Mechanical Data

- Case: TO252 (DPAK)
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 🔅
- Weight: 0.33 grams (Approximate)



Top View





Ordering Information (Note 5)

Part Number	Case	Packaging
DMP6180SK3Q-13	TO252 (DPAK)	2,500/Tape & Reel

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

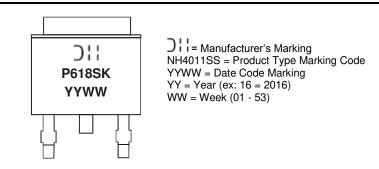
3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. Automotive products are AEC-Q101 qualified and are PPAP capable. Refer to http://www.diodes.com/product_compliance_definitions.html

5. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information

Notes:





Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Units		
Drain-Source Voltage	V _{DSS}	-60	V		
Gate-Source Voltage	V _{GSS}	±20	V		
Continuous Drain Current (Note 7) V_{GS} = -10V	Steady State	T _C = +25°C T _C = +100°C	I _D	-14 -10	А
Maximum Body Diode Forward Current (Note 7)	Is	4.1	А		
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)			I _{DM}	25	А

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Units		
Tatal Bawar Dissinction (Nata 6)	T _A = +25°C	P	1.7	W	
Total Power Dissipation (Note 6)	$T_A = +70^{\circ}C$	PD	1.0		
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	Deve	76	°C/W	
memai resistance, sunction to Ambient (Note 6)	T < 10s	R _{0JA}	33		
Total Power Dissipation (Note 7)	T _A = +25°C	D	2.7	W	
Total Fower Dissipation (Note 7)	$T_A = +70^{\circ}C$	PD	1.5		
Thermal Resistance. Junction to Ambient (Note 7)	Steady State	D	50	°C/W	
mermai Resistance, Junction to Ambient (Note 7)	t < 10s	R _{0JA}	24		
Tatal Bawar Dissinction (Nata 7)	$T_{\rm C} = +25^{\circ}{\rm C}$		40	w	
Total Power Dissipation (Note 7)	T _C = +100°C	PD	16	vv	
Thermal Resistance, Junction to Case (Note 7)	Steady State	R _{eJC}	3.1	°C/W	
Operating and Storage Temperature Range	·	T _{J.} T _{STG}	-55 to +150	°C	

Electrical Characteristics (@T_A = $\pm 25^{\circ}$ C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)							
Drain-Source Breakdown Voltage	BV _{DSS}	-60	—	—	V	$V_{GS} = 0V, I_D = -250 \mu A$	
Zero Gate Voltage Drain Current	I _{DSS}		_	-1	μA	$V_{DS} = -48V, V_{GS} = 0V$	
Gate-Source Leakage	IGSS	_	_	100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 8)							
Gate Threshold Voltage	V _{GS(TH)}	-1.2	_	-2.7	V	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	
Static Drain-Source On-Resistance		_	60	110	m0	$V_{GS} = -10V, I_D = -12A$	
Static Drain-Source On-Resistance	R _{DS(ON)}	_	80	140	mΩ	V _{GS} = -4.5V, I _D =-8A	
Forward Transfer Admittance	Y _{FS}	_	15	—	S	V _{DS} = -5V, I _D = -12A	
Diode Forward Voltage	V _{SD}	_	-0.7	-1.0	V	$V_{GS} = 0V, I_{S} = -1A$	
DYNAMIC CHARACTERISTICS (Note 9)							
Input Capacitance	CISS	_	984.7	_			
Output Capacitance	C _{OSS}		58	_	pF	$V_{DS} = -30V, V_{GS} = 0V, f = 1.0MHz$	
Reverse Transfer Capacitance	CRSS	_	45.5	_			
Gate Resistance	R _G	_	12.9	_	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$	
Total Gate Charge (V _{GS} = -4.5V)	Q _G	_	8.1	_			
Total Gate Charge (V _{GS} = -10V)	Q _G	_	17.1	_	nC	$V_{DS} = -30V, I_D = -12A$	
Gate-Source Charge	Q _{GS}		3.2		no		
Gate-Drain Charge	Q _{GD}	_	3.9	_			
Turn-On Delay Time	t _{D(ON)}	_	5.9	_			
Turn-On Rise Time	t _R	_	21.2	_		$V_{GS} = -10V, V_{DS} = -30V, R_{GEN} = 3\Omega,$	
Turn-Off Delay Time	t _{D(OFF)}	_	30.9	_	ns	$R_L = 2.5\Omega$	
Turn-Off Fall Time	t _F		39.1	_	1		
Body Diode Reverse Recovery Time	t _{RR}		19.9	_	ns	I _S = -12A, dl/dt = 100A/µs	
Body Diode Reverse Recovery Charge	Q _{RR}		1.7	—	nC	I _S = -12A, dl/dt = 100A/µs	

Notes: 6. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.

7. Device mounted on FR-4 substrate PC board, 2oz copper, with 1-inch square copper pad layout.

8. Short duration pulse test used to minimize self-heating effect

9. Guaranteed by design. Not subject to production testing

DMP6180SK3Q

125°C

= 150°C Τ_A

 $T_A = 85^{\circ}C$

TA = 25°C

TA -55°C

2

 $T_A = 85^{\circ}C$

10

-I_D, DRAIN CURRENT (A)

 $T_A = -55^{\circ}C$

V_{GS} = -4.5V I_D = -5.0A

 $T_A = 25^{\circ}C$

25

50

75

100

3

4

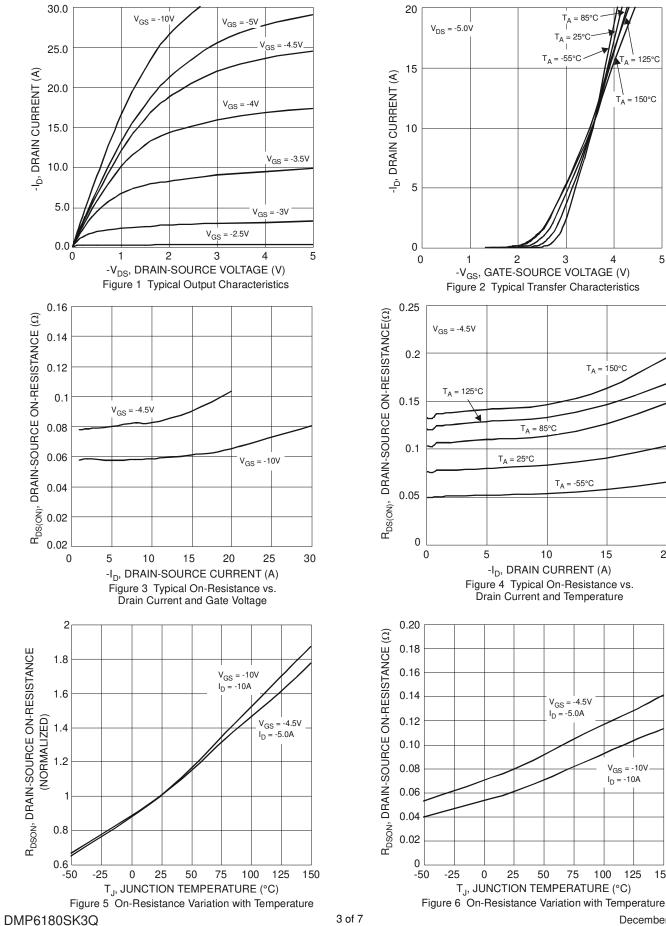
 $T_A = 150^{\circ}C$

15

5

20







150

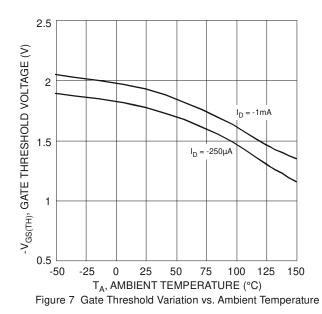
 $V_{GS} = -10V$ I_D = -10A

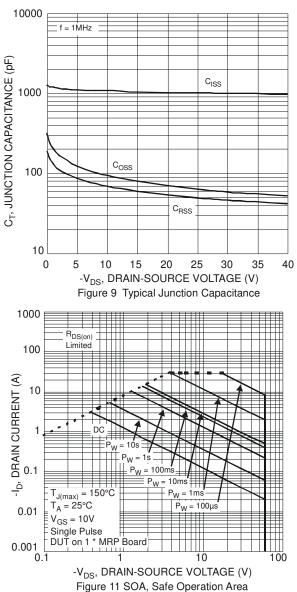
125

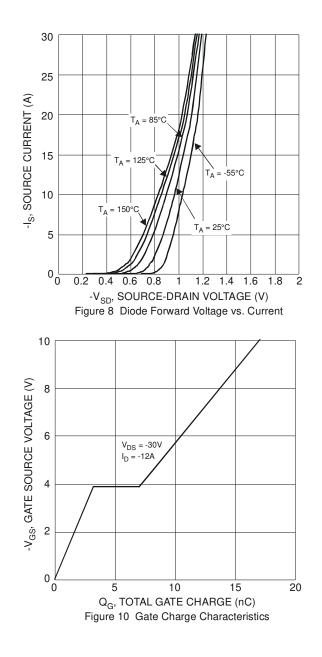
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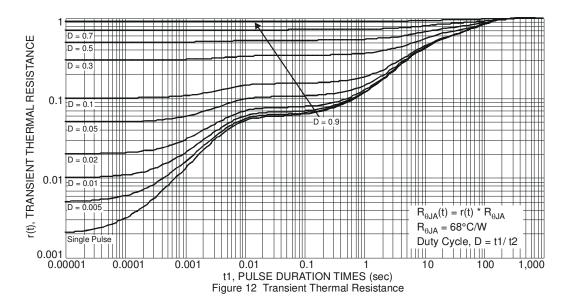








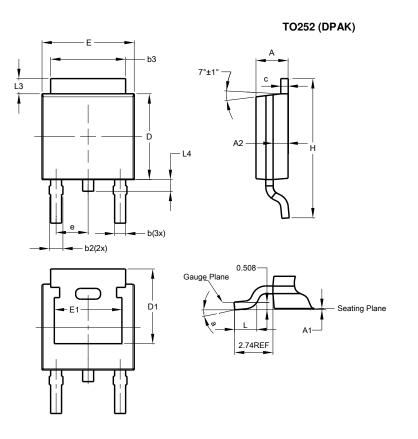






Package Outline Dimensions

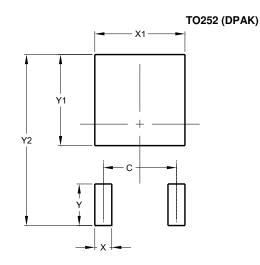
Please see http://www.diodes.com/package-outlines.html for the latest version.



TO252 (DPAK)						
Dim	Min	Max	Тур			
Α	2.19	2.39	2.29			
A1	0.00	0.13	0.08			
A2	0.97	1.17	1.07			
b	0.64	0.88	0.783			
b2	0.76	1.14	0.95			
b3	5.21	5.46	5.33			
С	0.45	0.58	0.531			
D	6.00	6.20	6.10			
D1	5.21	-	-			
е	-	-	2.286			
Ε	6.45	6.70	6.58			
E1	4.32	-	-			
Н	9.40	10.41	9.91			
L	1.40	1.78	1.59			
L3	0.88	1.27	1.08			
L4	0.64	1.02	0.83			
а	0°	10°	-			
All	Dimen	sions i	n mm			

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value (in mm)				
С	4.572				
Х	1.060				
X1	5.632				
Y	2.600				
Y1	5.700				
Y2	10.700				



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